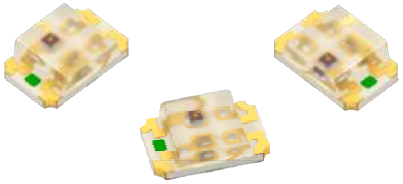
Kingbright



APHBM2012LSURKZGKC

2.0 x 1.25 mm SMD Chip LED Lamp

DESCRIPTIONS

- The Hyper Red source color devices are made with AlGaInP on GaAs substrate Light Emitting Diode
- The Green source color devices are made with InGaN on Sapphire Light Emitting Diode
- Electrostatic discharge and power surge could damage the LEDs
- It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs
- All devices, equipments and machineries must be electrically grounded

FEATURES

- 2.0 mm x 1.25 mm SMD LED, 0.45 mm max. thickness
- Low power consumption
- Wide viewing angle
- Ideal for backlight and indicator
- Package: 2000 pcs / reel
- Moisture sensitivity level: 3
- Halogen-free
- RoHS compliant

APPLICATIONS

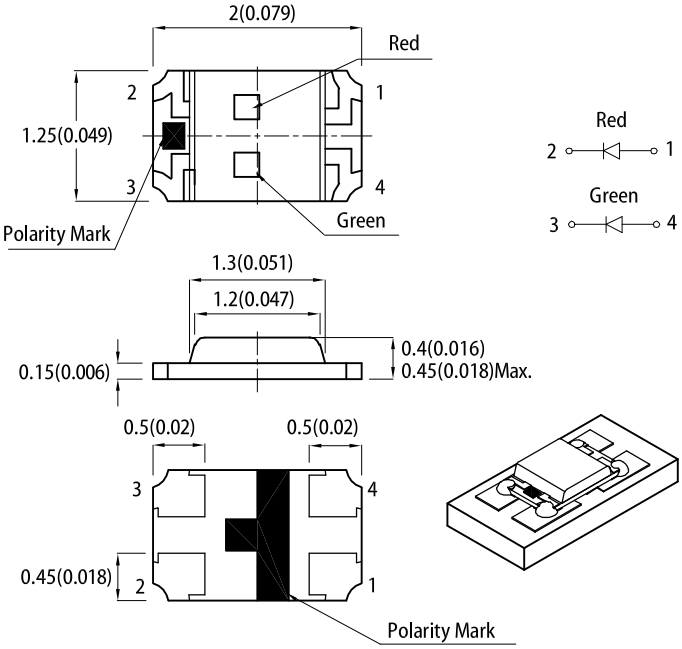
- Backlight
- Status indicator
- Home and smart appliances
- Wearable and portable devices
- Healthcare applications

ATTENTION

Observe precautions for handling electrostatic discharge sensitive devices

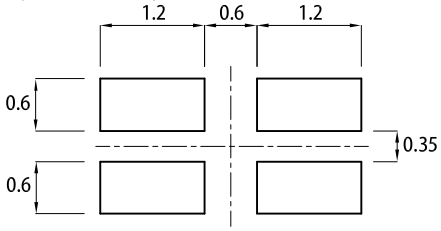


PACKAGE DIMENSIONS



RECOMMENDED SOLDERING PATTERN

(units : mm; tolerance : ± 0.1)



Notes:
1. All dimensions are in millimeters (inches).
2. Tolerance is ±0.1(0.004") unless otherwise noted.
3. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.
4. The device has a single mounting surface. The device must be mounted according to the specifications.

SELECTION GUIDE

Part Number	Emitting Color (Material)	Lens Type	Iv (mcd) @ 2mA [2]		Viewing Angle [1]
			Min.	Typ.	2θ1/2
APHBM2012LSURKZGKC	Hyper Red (AlGaInP)	Water Clear	15	30	120°
			*6	*15	
	Green (InGaN)		50	90	
			*50	*90	

Notes:
1. θ1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
2. Luminous intensity / luminous flux: +/-15%.
** Luminous intensity value is traceable to CIE127-2007 standards.*

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ELECTRICAL / OPTICAL CHARACTERISTICS at T_A=25°C

Parameter	Symbol	Emitting Color	Value			Unit
			Min.	Typ.	Max.	
Wavelength at Peak Emission I_F = 2mA	λ_{peak}	Hyper Red Green	-	645 515	-	nm
Dominant Wavelength I_F = 2mA	λ_{dom} [1]	Hyper Red Green	-	630 525	-	nm
Spectral Bandwidth at 50% Φ REL MAX I_F = 2mA	Δλ	Hyper Red Green	-	28 35	-	nm
Forward Voltage I_F = 2mA	V_F [2]	Hyper Red Green	1.5 2.2	1.75 2.65	2.1 3.1	V
Reverse Current (V_R = 5V)	I_R	Hyper Red Green	-	-	10 50	μA
Temperature Coefficient of λ_{peak} I_F = 2mA, -10°C ≤ T ≤ 85°C	$TC_{\lambda peak}$	Hyper Red Green	-	0.14 0.05	-	nm/°C
Temperature Coefficient of λ_{dom} I_F = 2mA, -10°C ≤ T ≤ 85°C	$TC_{\lambda dom}$	Hyper Red Green	-	0.05 0.03	-	nm/°C
Temperature Coefficient of V_F I_F = 2mA, -10°C ≤ T ≤ 85°C	TC_V	Hyper Red Green	-	-1.9 -3.0	-	mV/°C

Notes:
1. The dominant wavelength (λd) above is the setup value of the sorting machine. (Tolerance λd : ±1nm.)
2. Forward voltage: ±0.1V.
3. Wavelength value is traceable to CIE127-2007 standards.
4. Excess driving current and / or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

ABSOLUTE MAXIMUM RATINGS at T_A=25°C

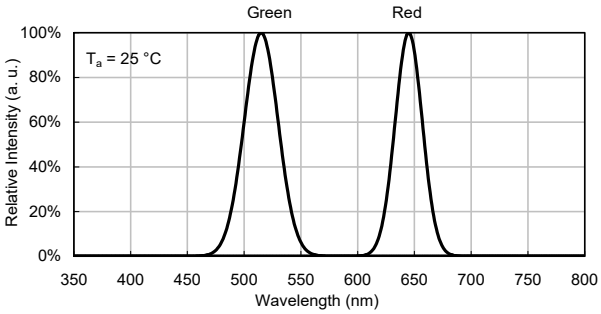
Parameter	Symbol	Value		Unit
		Hyper Red	Green	
Power Dissipation	P_D	75	102.5	mW
Reverse Voltage	V_R	5	5	V
Junction Temperature	T_J	115	115	°C
Operating Temperature	T_{op}	-40 to +85		°C
Storage Temperature	T_{stg}	-40 to +85		°C
DC Forward Current	I_F	30	25	mA
Peak Forward Current	I_{FP} [1]	185	150	mA
Electrostatic Discharge Threshold (HBM)	-	3000	450	V
Thermal Resistance (Junction / Ambient)	$R_{th\ JA}$ [2]	750	510	°C/W
Thermal Resistance (Junction / Solder point)	$R_{th\ JS}$ [2]	620	380	°C/W

Notes:
1. 1/10 Duty Cycle, 0.1ms Pulse Width.
2. $R_{th\ JA}$,$R_{th\ JS}$ Results from mounting on PC board FR4 (pad size ≥ 16 mm^2 per pad).
3. Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity – Ref JEDEC/JESD625-A and JEDEC/J-STD-033.

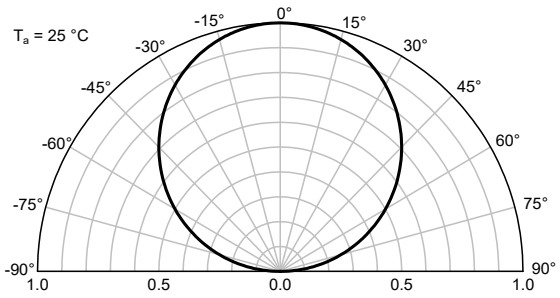
RoHS © 2025 Kingbright. All Rights Reserved.

TECHNICAL DATA

RELATIVE INTENSITY vs. WAVELENGTH

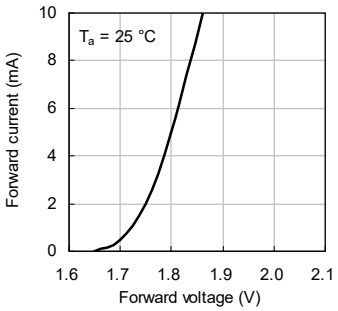


SPATIAL DISTRIBUTION

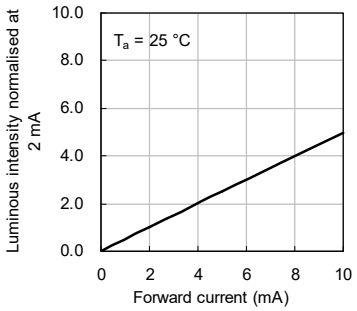


HYPER RED

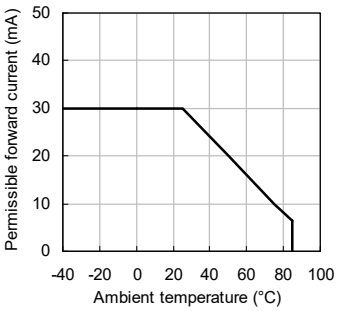
Forward Current vs. Forward Voltage



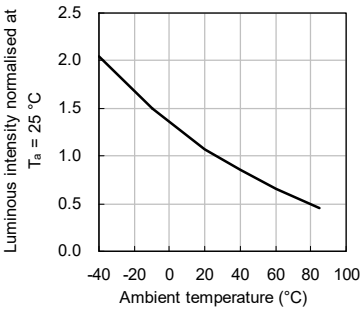
Luminous Intensity vs. Forward Current



Forward Current Derating Curve

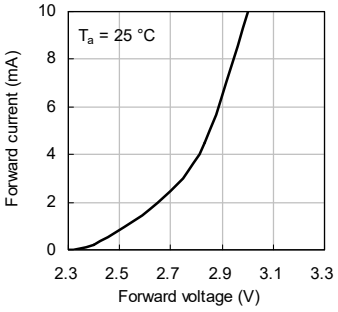


Luminous Intensity vs. Ambient Temperature

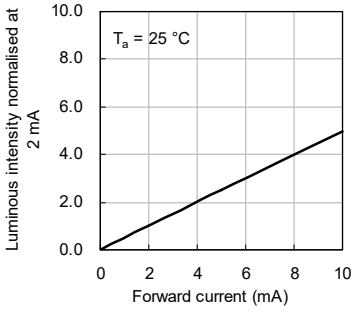


GREEN

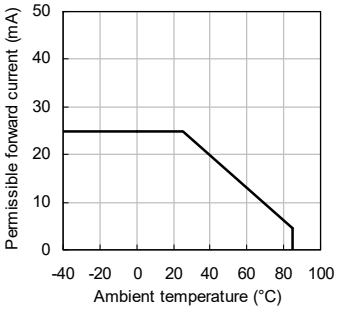
Forward Current vs. Forward Voltage



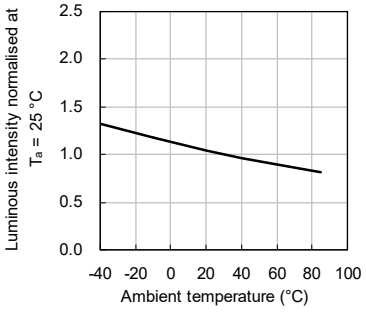
Luminous Intensity vs. Forward Current



Forward Current Derating Curve

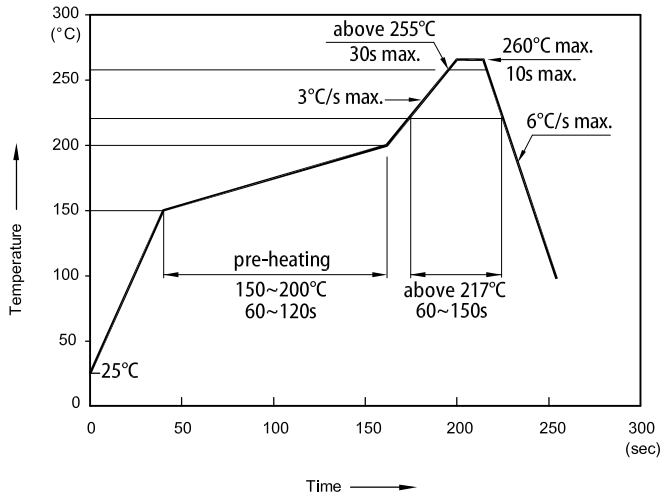


Luminous Intensity vs. Ambient Temperature



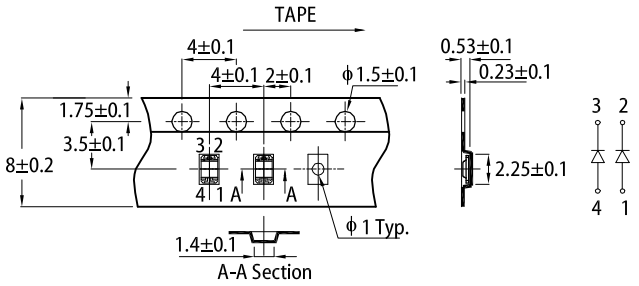
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REFLOW SOLDERING PROFILE for LEAD-FREE SMD PROCESS

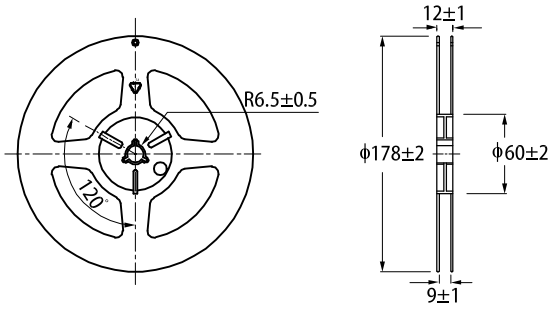


Notes:
1. Don't cause stress to the LEDs while it is exposed to high temperature.
2. The maximum number of reflow soldering passes is 2 times.
3. Reflow soldering is recommended. Other soldering methods are not recommended as they might cause damage to the product.

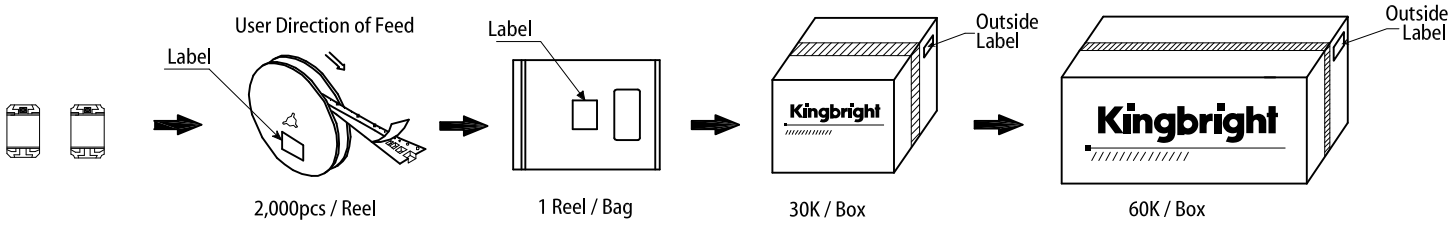
TAPE SPECIFICATIONS (units : mm)

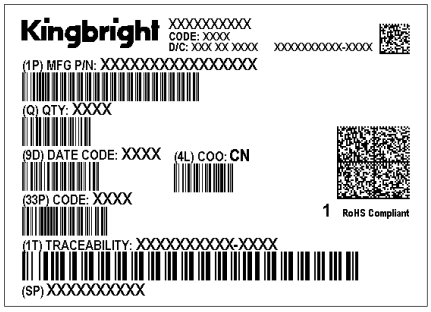


REEL DIMENSION (units : mm)



PACKING & LABEL SPECIFICATIONS





PRECAUTIONARY NOTES

1. The information included in this document reflects representative usage scenarios and is intended for technical reference only.
2. The part number, type, and specifications mentioned in this document are subject to future change and improvement without notice. Before production usage customer should refer to the latest datasheet for the updated specifications.
3. When using the products referenced in this document, please make sure the product is being operated within the environmental and electrical limits specified in the datasheet. If customer usage exceeds the specified limits, Kingbright will not be responsible for any subsequent issues.
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